

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of http://www.nxp.com, http://www.nxp.com, http://www.nexperia.com, http://www.nexperia.com)

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use salesaddresses@nexperia.com (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia



PMBT2222; PMBT2222A

NPN switching transistors

Rev. 6 — 12 November 2010

Product data sheet

1. Product profile

1.1 General description

NPN switching transistors in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package		PNP complement
	NXP	JEDEC	
PMBT2222	SOT23	TO-236AB	PMBT2907
PMBT2222A			PMBT2907A

1.2 Features and benefits

- High current (max. 600 mA)
- Low voltage (max. 40 V)

1.3 Applications

Switching and linear amplification

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base				
	PMBT2222		-	-	30	V
	PMBT2222A		-	-	40	V
I _C	collector current		-	-	600	mA
h _{FE}	DC current gain	$V_{CE} = 10 \text{ V};$ $I_{C} = 150 \text{ mA}$	<u>II</u> 100	-	300	
	PMBT2222	$V_{CE} = 10 \text{ V};$ $I_{C} = 500 \text{ mA}$	<u>[1]</u> 30	-	-	
	PMBT2222A	$V_{CE} = 10 \text{ V};$ $I_{C} = 500 \text{ mA}$	<u>11</u> 40	-	-	

^[1] Pulse test: $t_p \leq 300~\mu s; \, \delta \leq 0.02.$



2. Pinning information

Table 3. Pinning

iubic o.	i iiiiiiig		
Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter	3	3
3	collector	1 2	1—
			2 sym021

3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
PMBT2222	-	plastic surface-mounted package; 3 leads	SOT23
PMBT2222A			

4. Marking

Table 5. Marking codes

Type number	Marking code ^[1]
PMBT2222	*1B
PMBT2222A	*1P

^{[1] * =} placeholder for manufacturing site code

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter			
	PMBT2222		-	60	V
	PMBT2222A		-	75	V
V_{CEO}	collector-emitter voltage	open base			
	PMBT2222		-	30	V
	PMBT2222A		-	40	V
V_{EBO}	emitter-base voltage	open collector			
	PMBT2222		-	5	V
	PMBT2222A		-	6	V
I _C	collector current		-	600	mA
I _{CM}	peak collector current		-	800	mA
I _{BM}	peak base current		-	200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	[1] -	250	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C
-					

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] -	-	500	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

7. Characteristics

Table 8. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current						
	PMBT2222	$V_{CB} = 50 \text{ V}; I_{E} = 0 \text{ A}$		-	-	10	nA
		$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A};$ $T_j = 125 \text{ °C}$		-	-	10	μΑ
	collector-base cut-off current						
	PMBT2222A	$V_{CB} = 60 \text{ V}; I_{E} = 0 \text{ A}$		-	-	10	nA
		$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A};$ $T_j = 125 \text{ °C}$		-	-	10	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	10	nA
h _{FE}	DC current gain	$V_{CE} = 10 \text{ V};$ $I_{C} = 0.1 \text{ mA}$		35			
		$V_{CE} = 10 \text{ V};$ $I_C = 1 \text{ mA}$		50	-	-	
		$V_{CE} = 10 \text{ V};$ $I_{C} = 10 \text{ mA}$		75	-	-	
		$V_{CE} = 10 \text{ V};$ $I_{C} = 10 \text{ mA};$ $T_{amb} = -55 \text{ °C}$		35	-	-	
		$V_{CE} = 10 \text{ V};$ $I_{C} = 150 \text{ mA}$	[1]	100	-	300	
		$V_{CE} = 1 \text{ V};$ $I_C = 150 \text{ mA}$	<u>[1]</u>	50	-	-	
	DC current gain	$V_{CE} = 10 \text{ V};$ $I_{C} = 500 \text{ mA}$	[1]				
	PMBT2222			30	-	-	
	PMBT2222A			40	-	-	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 150 \text{ mA};$ $I_B = 15 \text{ mA}$	<u>[1]</u>				
	PMBT2222			-	-	400	mV
	PMBT2222A			-	-	300	mV
	collector-emitter saturation voltage	$I_C = 500 \text{ mA};$ $I_B = 50 \text{ mA}$	[1]				
	PMBT2222			-	-	1.6	٧
	PMBT2222A			-	-	1	V

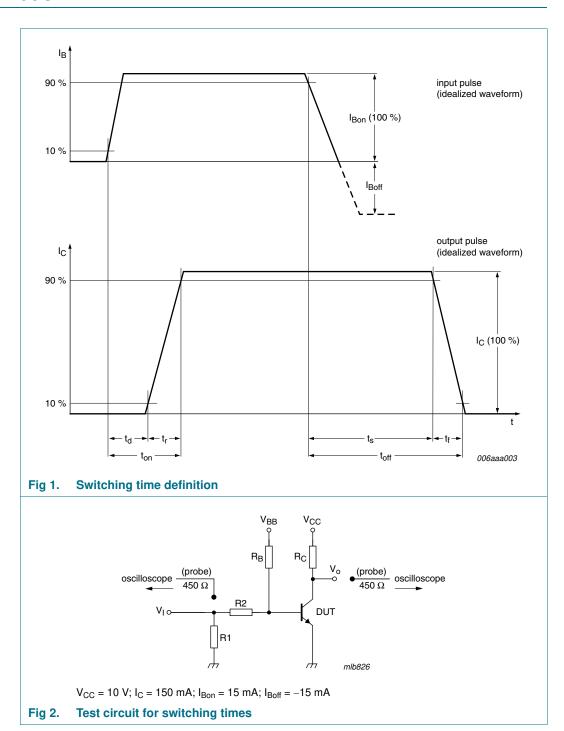
 Table 8.
 Characteristics ...continued

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{BEsat}	base-emitter saturation voltage	$I_C = 150 \text{ mA};$ $I_B = 15 \text{ mA}$	<u>[1]</u>			
	PMBT2222		-	-	1.3	V
	PMBT2222A		0.6	-	1.2	V
	base-emitter saturation voltage	$I_C = 500 \text{ mA};$ $I_B = 50 \text{ mA}$	<u>[1]</u>			
	PMBT2222		-	-	2.6	V
	PMBT2222A		-	-	2	V
C _c	collector capacitance	$V_{CB} = 10 \text{ V};$ $I_E = i_e = 0 \text{ A};$ $f = 1 \text{ MHz}$	-	-	8	pF
C _e	emitter capacitance	$V_{EB} = 500 \text{ mV};$ $I_C = i_C = 0 \text{ A};$ f = 1 MHz				
	PMBT2222		-	-	30	рF
	PMBT2222A		-	-	25	рF
f _T	transition frequency	V _{CE} = 20 V; I _C = 20 mA; f = 100 MHz				
	PMBT2222		250	-	-	MHz
	PMBT2222A		300	-	-	MHz
NF	noise figure	$V_{CE} = 5 \text{ V};$ $I_{C} = 100 \mu\text{A};$ $R_{S} = 1 k\Omega;$ $f = 1 k\text{Hz}$	-	-	4	dB
t _d	delay time	$V_{CC} = 10 \text{ V};$	-	-	15	ns
t _r	rise time	¯ I _C = 150 mA; – I _{Bon} = 15 mA;	-	-	20	ns
t _{on}	turn-on time	$I_{Boff} = -15 \text{ mA}$	-	-	35	ns
ts	storage time	-	-	-	200	ns
t _f	fall time		-	-	60	ns
t _{off}	turn-off time		-	-	250	ns

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

8. Test information



8.1 Quality information

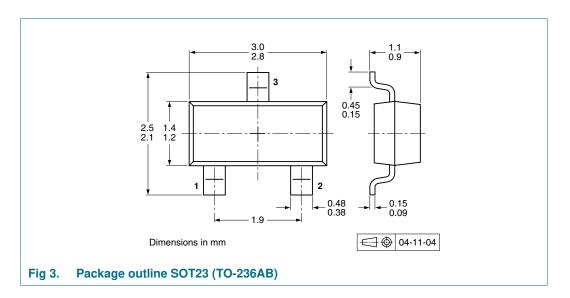
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

PMBT2222_PMBT2222A

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2010. All rights reserved.

9. Package outline



10. Packing information

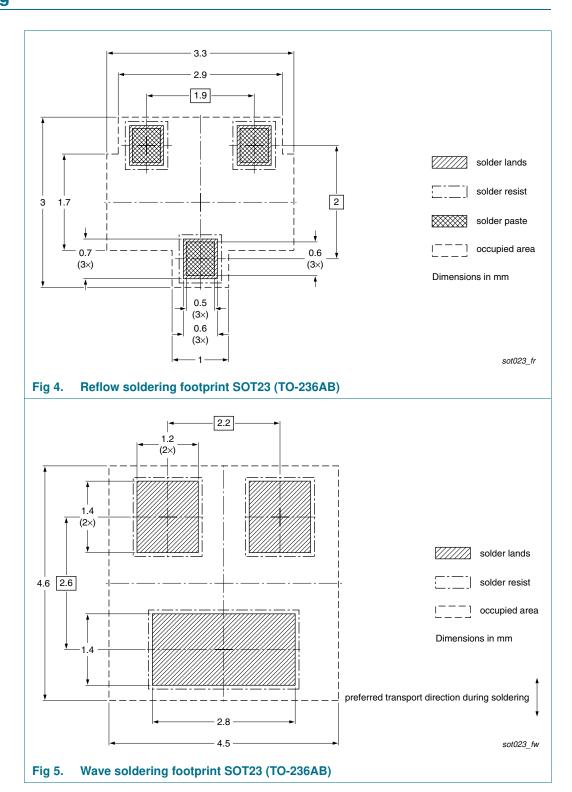
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	ge Description		Packing quantity		
			3000	10000		
PMBT2222	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235		
PMBT2222A						

^[1] For further information and the availability of packing methods, see Section 14.

11. Soldering



12. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMBT2222_PMBT2222A v.6	20101112	Product data sheet	-	PMBT2222_2222A_5
Modifications:	 Section 4 "N 	larking": updated		
	 Figure 1 "Sw 	vitching time definition": added	d	
	Section 8 "Te	est information": updated		
	Section 10 "	Packing information": added		
	• <u>Section 11 "S</u>	Soldering": added		
	 Section 13 " 	Legal information": updated		
PMBT2222_2222A_5	20040122	Product specification	-	PMBT2222_2222A_4
PMBT2222_2222A_4	19990427	Product specification	-	PMBT2222_3
PMBT2222_3	19970909	Product specification	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

13.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

PMBT2222_PMBT2222A

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2010. All rights reserved.

PMBT2222; PMBT2222A

NPN switching transistors

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

14. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

15. Contents

1	Product profile
1.1	General description
1.2	Features and benefits
1.3	Applications
1.4	Quick reference data 1
2	Pinning information
3	Ordering information
4	Marking 2
5	Limiting values
6	Thermal characteristics 3
7	Characteristics 4
8	Test information 6
8.1	Quality information 6
9	Package outline
10	Packing information 7
11	Soldering 8
12	Revision history 9
13	Legal information
13.1	Data sheet status
13.2	Definitions
13.3	Disclaimers
13.4	Trademarks11
14	Contact information
15	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.